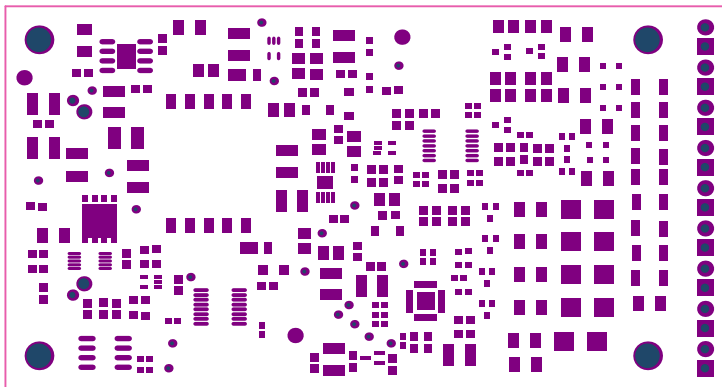
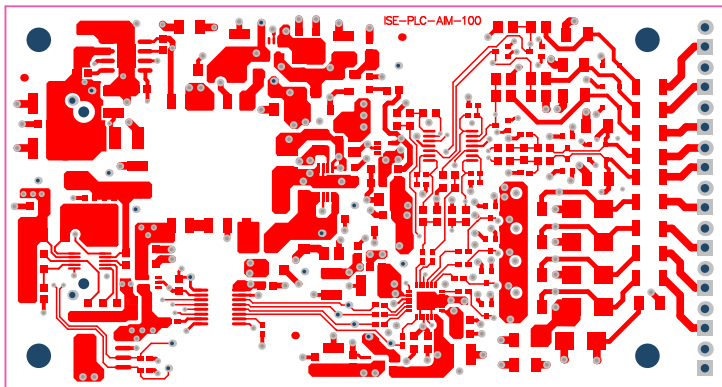


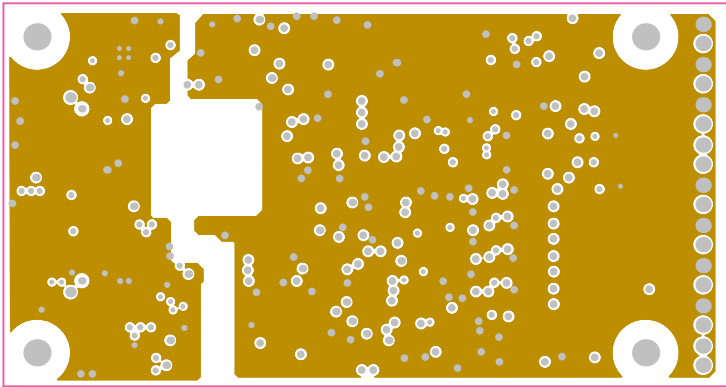
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 1/16/2014 9:06:54 PM	TEXAS INSTRUMENTS	



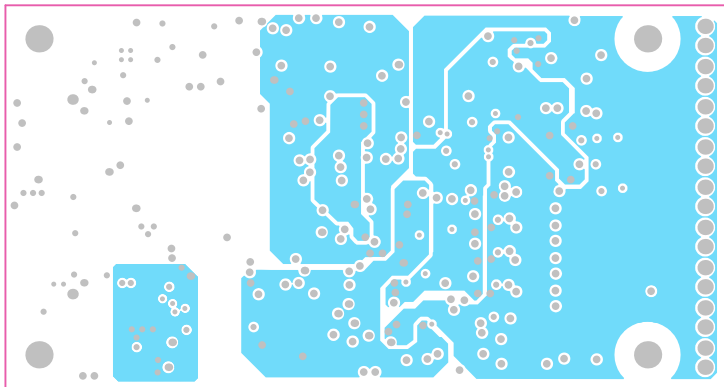
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 1/16/2014 9:06:55 PM	TEXAS INSTRUMENTS	



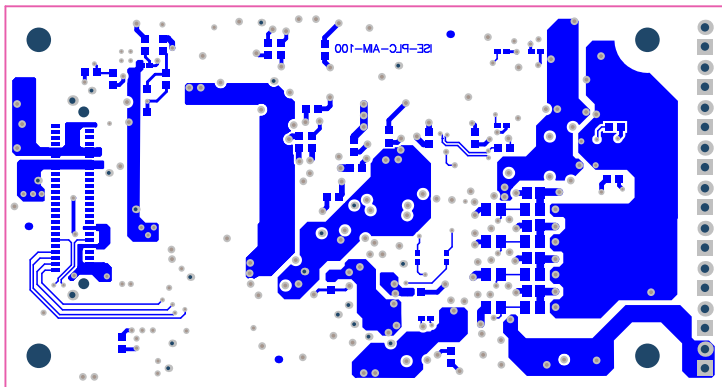
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 1/16/2014 9:06:56 PM	TEXAS INSTRUMENTS	



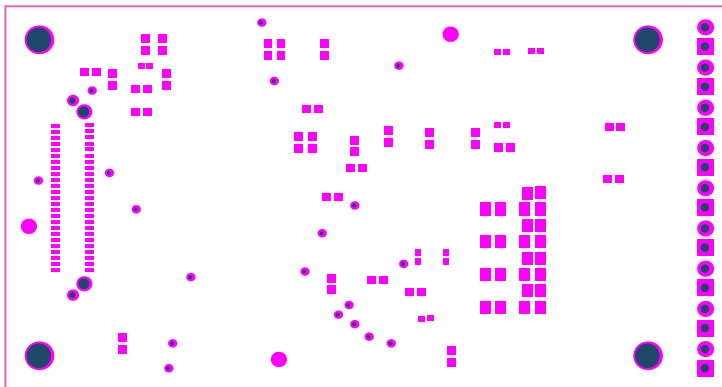
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = L2_GND-PLANE			
PLOT NAME = GND_PLANE1	GENERATED : 1/16/2014 9:06:56 PM	TEXAS INSTRUMENTS	



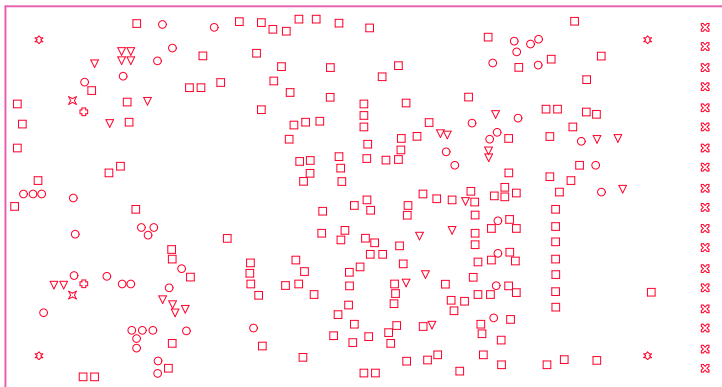
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = L3_PWR-PLANE			
PLOT NAME = PWR_PLANE2	GENERATED : 1/16/2014 9:06:57 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 1/16/2014 9:06:57 PM	TEXAS INSTRUMENTS	



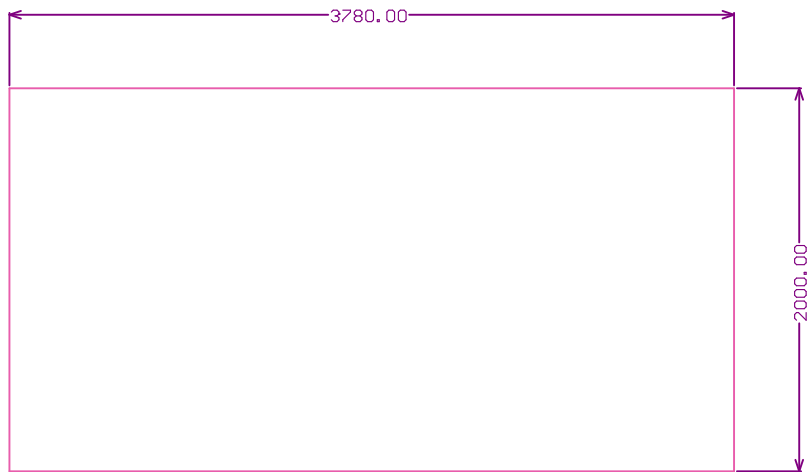
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 1/16/2014 9:06:58 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
▽	27	12mil (0.305mm)	PTH	Round
○	49	16mil (0.406mm)	PTH	Round
□	176	20mil (0.508mm)	PTH	Round
⊗	2	33mil (0.838mm)	PTH	Round
⊗	18	44mil (1.118mm)	PTH	Round
⊗	2	57.087mil (1.45mm)	NPTH	Round
⊗	4	128mil (3.251mm)	NPTH	Round
278 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 1/16/2014	9:06:59 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0076	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 1/16/2014	9:06:59 PM	TEXAS INSTRUMENTS

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